# imall

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## Features

- 3210 2.1mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

## Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

## Description

The IN-S121DASRYG is a dual-color 3210 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

## **Recommended Solder Pattern**

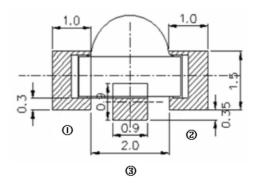


Figure 1. IN-S121DASRYG Solder Pattern

## Package Dimensions in mm

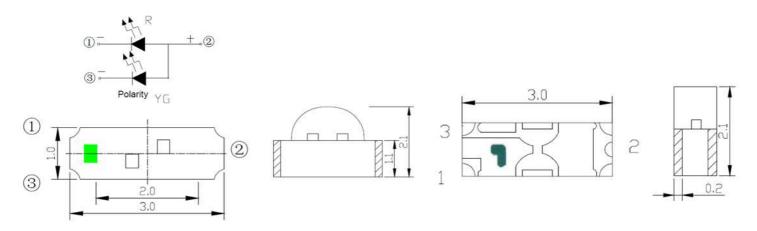


Figure 2. IN-S121DASRYG Package Dimensions



## Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	Top (°C)	Ts⊤ (ºC)	
	Red		25	70		-30°C~+85°C	-40°C~+90°C	
IN-S121DASRYG	Yellow Green	75		70	5			

#### Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

#### **ESD** Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

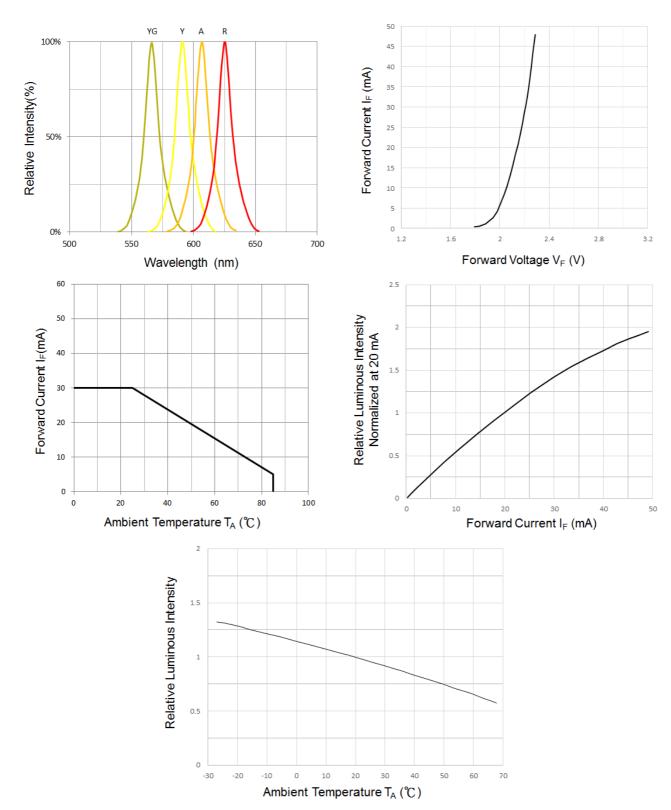
## Electrical Characteristics $T_A = 25C$ (Note 1)

Product	Emission		VF(V)			λ(nm)	Viewing Angel	l*∨(mcd)	
	Color	l⊧(mA)	typ.	max	λ	λP	∆ک	<b>2</b> \theta 1/2	typ.
IN-S121DASRYG	Red	20	2.2	2.6	622	630	20	130	110
	Yellow Green	20	2.2	2.6	573	576	15	130	30

#### Notes

1. Performance guaranteed only under conditions listed in above tables.

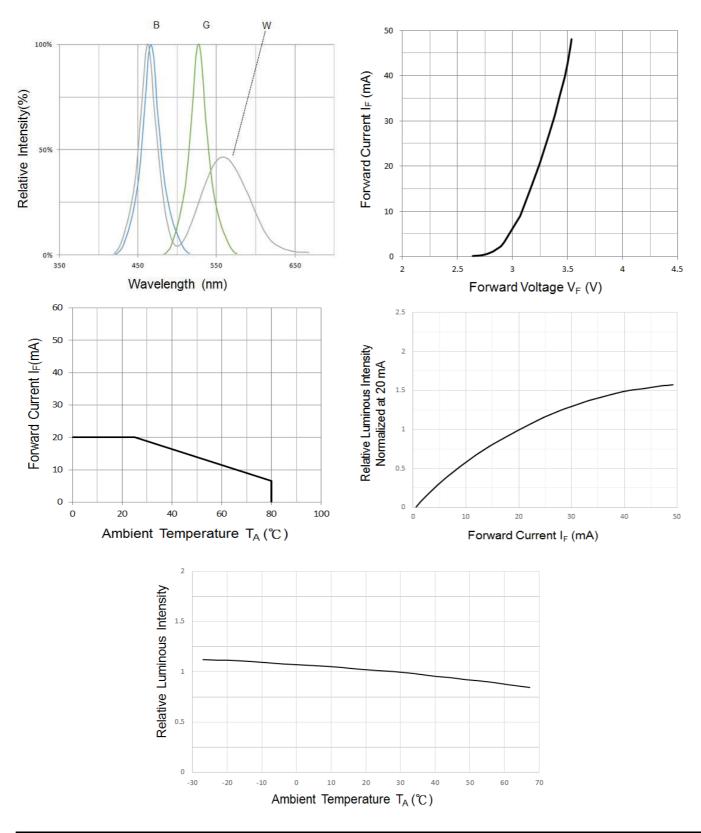




## Typical Characteristic Curves – YG, Y, A, R

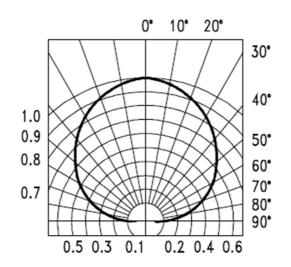


## Typical Characteristic Curves – B, G, W





## **Typical Characteristic Curves – Radiation Pattern**

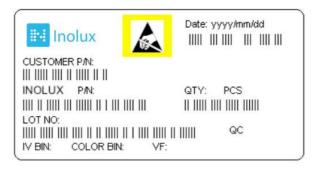


## **Ordering Information**

Product	Emission Color	Test Current I <sub>F</sub> (mA)	Luminous Intensity I <sub>V</sub> (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
	Red	20	110	2.2	
IN-S121DASRYG	Yellow Green	20	30	2.2	IN-S121DASRYG



## Label Specifications



## Inolux P/N:

Ι	Ν	-	S	1	2	1	D	А	S			R	YG		-	Х	x x	X
			Material		Packag	je	Varia	ation	Orientation	Current	Lens	Co	lor	Chip Type			tomi imp-	
	lux ИD		S = PCB Type	12	21DA = 3	3.0 x 1	.0 x 2.1	lmm	S= Side Mount	(Blank) = 20mA	(Blank) = Clear		30nm 76nm	(blank) = Standard				

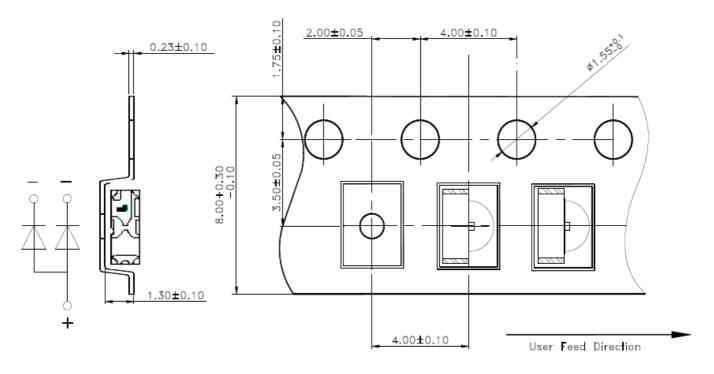
#### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019	Month	Data	Sorial	
Tracker		Year (2017	, 2010,)	wonth	Date	Serial	

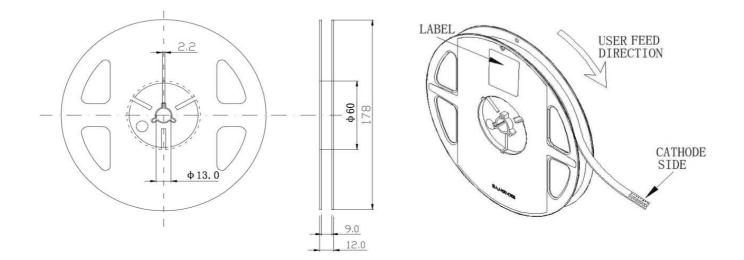


## Packaging Information: 2000pcs Per Reel

## Tape Dimension



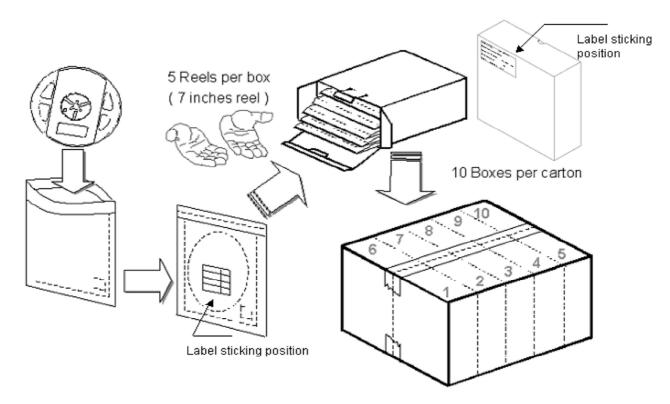
## **Reel Dimension**





## IN-S121DASRYG Side View SMD LED 3210 PCB Type

## Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

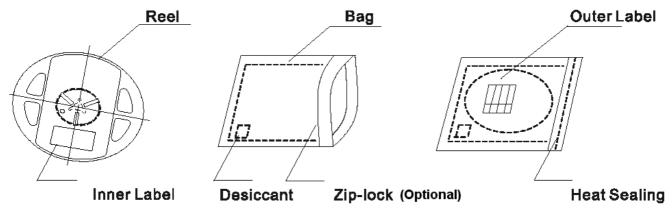


## **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

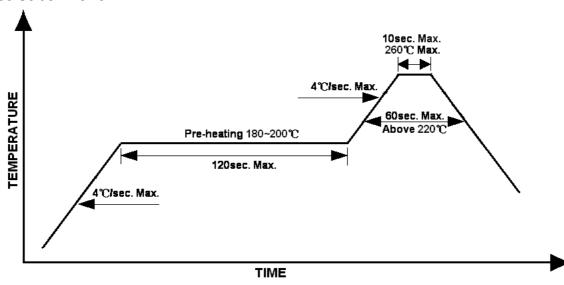
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



## **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



## Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

## Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

## Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

## **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



## Reliability

Item	Frequency/ lots/ samples/	Standards	Conditions		
item	failures	Reference			
	For all reliability	J-STD-020	1.) Baking at 85℃ for 24hrs		
Precondition	monitoring tests according		2.) Moisture storage at 85℃/ 60% R.H. for		
	to JEDEC Level 2		168hrs		
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155℃/ 24hrs		
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s		
			Tinning: A: 215℃/ 3+1s or B: 260℃/ 10+1s		
		CNS-5067	Dipping soldering terminal only		
Resistance to			Soldering bath temperature		
soldering heat			A: 260+/-5℃; 10+/-1s		
Ŭ			B: 350+/-10°C; 3+/-0.5s		
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C bakin g for 24hrs		
Operating life test			85°C/ 60%R.H. for 168hrs		
			2.) Tamb25℃; IF=20mA; duration 1000hrs		
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C		
high temperature			Humidity: 85% R.H., IF=5mA		
bias			Duration: 1000hrs		
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55℃		
bias			IF=20mA		
DIAS			Duration: 1000hrs		
	1Q/ 1/ 40/ 0		Tamb25℃, If=20mA,, Ip=100mA, Duty		
Pulse life test			cycle=0.125 (tp=125 µ s,T=1sec)		
			Duration 500hrs)		
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C		
Tampavatura		IEC 68-2-14, Nb	15min		
Temperature			Thermal steady within 5 min		
cycle			300 cycles		
			2 chamber/ Air-to-air type		
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C		
storage test			90+5/-10% R.H. for 500hrs		
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10℃ for 500hrs		
storage test					
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5℃ for 500hrs		
storage test					



## **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	05-12-2017

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